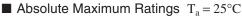
UNR8231/8231A (UN8231/8231A)

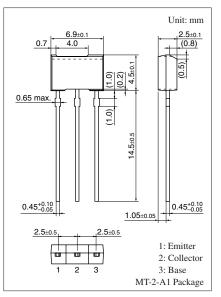
Silicon NPN epitaxial planar type

For switching

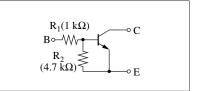
- Features
- High forward current transfer ratio h_{FE}
- Resistor built-in type, allowing downsizing of the equipment and reduction of the number of parts
- Available in a type with radial taping

er	Symbol	Rating	Unit						
UNR8231	V _{CBO}	20	V						
UNR8231A		60							
UNR8231	V _{CEO}	20	V						
UNR8231A		50							
	I _C	0.7	А						
	I _{CP}	1.5	А						
Total power dissipation *			W						
	Tj	150	°C						
	T _{stg}	-55 to +150	°C						
	UNR8231A UNR8231 UNR8231A	UNR8231 V _{CBO} UNR8231A V _{CEO} UNR8231A V _{CEO} UNR8231A I _C ICP I _{CP} n* P _T T _j T _j	$\begin{array}{c c c c c c c c c c c c c c c c c c c $						





Internal Connection



Note) *: Printed circuit board: Copper foil area of 1 cm² or more, and the board thickness of 1.7 mm for the collector portion

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

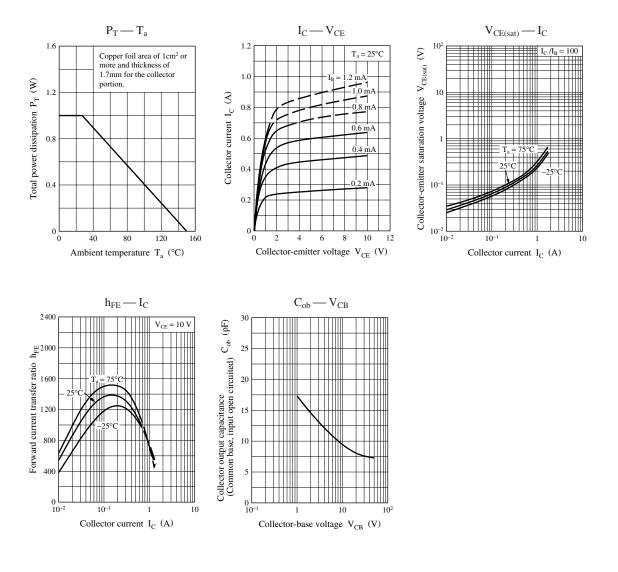
Paramete	r	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage	UNR8231	V _{CBO}	$I_{\rm C} = 10 \ \mu A, \ I_{\rm E} = 0$	20			V
(Emitter open)	UNR8231A			60			
Collector-emitter	UNR8231	V _{CEO}	$I_{\rm C} = 1 \text{mA}, I_{\rm B} = 0$	20			V
voltage (Base open)	UNR8231A			50			
Collector-base cutoff currer	nt (Emitter open)	I _{CBO}	$V_{CB} = 15 \text{ V}, I_E = 0$			1	μΑ
Collector-emitter cutoff cur	rent (Base open)	I _{CEO}	$V_{CE} = 15 \text{ V}, I_B = 0$			10	μΑ
Emitter-base cutoff current	(Collector open)	I _{EBO}	$V_{EB} = 14 \text{ V}, I_C = 0$			0.5	mA
Forward current transf	er ratio *	h_{FE}	$V_{CE} = 10 \text{ V}, I_C = 150 \text{ mA}$	800		2100	
Collector-emitter saturat	ion voltage *	V _{CE(sat)}	$I_{C} = 500 \text{ mA}, I_{B} = 5 \text{ mA}$			0.4	V
Input resistance		R ₁		0.7	1.0	1.3	kΩ
Resistance ratio		R ₁ /R ₂		0.016	0.021	0.025	—
Transition frequency		f_T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: Pulse measurement

Note) The part numbers in the parenthesis show conventional part number.

Panasonic



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